



Comparisons of LD7575 & NXX1203

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| | Items | LD7575 | NXX1203 | Note |
|----|-----------------------------|------------------------|-----------------------------------|---|
| 1 | Vcc (max) | 30V | 16V | LD7575 is with wide operation voltage range. Usually, users need to add a zener |
| 2 | UVLO | 16V/10V | 12.8V/7.8V | diode on the Vcc of NXX1203 to prevent Vcc from damage. |
| 3 | Vcc OVP | With | Without | LD7575 provides better protection |
| 4 | OLP | With | Without | performance (OVP, OVP & short protection). |
| 5 | Driver Current | 500mA | 250mA | LD7575 is better for higher power application. |
| 6 | Frequency | Adjustable | Fix | Pin 1 of LD7575 is for frequency setting. |
| 7 | Vcs(max) | 0.85V | 1V | Lower power rating of sening resistor in LD7575 application. |
| 8 | ESD | 3KV | 2KV | LD7575 is with higher ESD level. |
| 9 | DSS TM Mode (*1) | Without | With | DSS mode will degrade the green-mode performance thus LD7575 is not implemented it. |
| 10 | High-V Current | 1mA | 6mA | LD7575's lower HV current will reduce the power dissipation and further reduce the need of internal OTP. (*2) |
| 11 | Pin 1 definition | RT (frequency setting) | ADJ (adjust the burst mode level) | Same PCB layout (connect a resistor to GND in both applications) |
| 12 | Slope Compensation | With | Without | |

^{*1} DSS mode --- dynamic self-supply is the trademark of On Semiconductor. It can be implemented for the applications which are without auxiliary transformer winding. However, on such applications, the power saving performance will become worse due to the continuous on-off on the HV current source. So that, LD7575 is not implemented such function.

*2 HV Current --- Even in the worst case (Vcc is shorted to GND), the generate power dissipation on the LD7575 is only $\sqrt{2} \cdot 264 Vac \cdot 1mA = 373 mW \ . \ \ \text{The generated heat can be self-dissipated by the SOP-8 package}$ itself. Further, the negative temperature coefficient characteristic will help to reduce the HV current and further to avoid the thermal run-away.